

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Sehat Sutardja Art Unit : Unknown
Serial No.: to be assigned Examiner : Unknown
Filed : HEREWITH
Title : IMPROVED INTEGRATED CHIP PACKAGE HAVING
INTERMEDIATE SUBSTRATE

JC978 U.S. PTO
09/966914
09/27/01

BOX PATENT APPLICATION

Commissioner for Patents
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Applicant submits the references listed on the attached
form PTO-1449, copies of which are enclosed.

This statement is being filed with the application. Please
apply any charges or credits to Deposit Account No. 06-1050.

Respectfully submitted,

Date: 9/27/01

Joseph L. Stevenson
Joseph L. Stevenson
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